

EV085429084

Inventor: Jeffrey W. Honeycutt et al.

Title: Methods of Forming Insulative Material Against Conductive Structures

17 / Suppl. IDS  
E. Villio  
4-4-03

Assignee: Micron Technology, Inc.

Serial No.: 09/651,422

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**SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT**

**PURSUANT TO 37 C.F.R. §§ 1.56, 1.97 AND 1.98**

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In compliance with 37 C.F.R. §§ 1.56, 1.97 and 1.98, the Examiner's attention is directed to the references listed on the attached Form PTO-1449 and copies of which are attached. No admission is made regarding whether all the submitted references are prior art.

Citation of these references is respectfully requested.

Respectfully submitted,

Date: 2/25/03

Attorney: [Signature]

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